

ISP626-1X, ISP626-2X, ISP626-4X
ISP626-1, ISP626-2, ISP626-4



ISOCOM

COMPONENTS



LOW INPUT CURRENT A.C. INPUT PHOTOTRANSISTOR OPTICALLY COUPLED ISOLATORS

APPROVALS

- UL recognised, File No. E91231
Package coe " EE "

'X' SPECIFICATION APPROVALS

- VDE 0884 in 3 available lead form :-
 - STD
 - Gform
 - SMD approved to CECC 00802
- ISP626-1X Certified to EN60950 by Nemko - Certificate No. P01102465

DESCRIPTION

The ISP626-1, ISP626-2, ISP626-4 series of optically coupled isolators consist of two infrared light emitting diodes connected in inverse parallel and NPN silicon photo transistors in space efficient dual in line plastic packages.

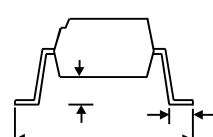
FEATURES

- Options :-
10mm lead spread - add G after part no.
Surface mount - add SM after part no.
Tape&reel - add SMT&R after part no.
- Low input current $\pm 0.5\text{mA}$ I_F
- High Isolation Voltage ($5.3\text{kV}_{\text{RMS}}$, 7.5kV_{PK})
- AC or polarity insensitive input
- All electrical parameters 100% tested
- Custom electrical selections available

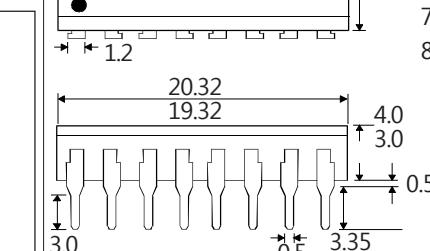
APPLICATIONS

- Computer terminals
- Industrial systems controllers
- Telephone sets, Telephone exchangers
- Signal transmission between systems of different potentials and impedances

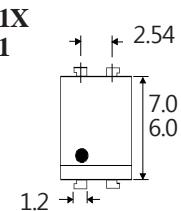
**OPTION SM
SURFACE MOUNT**



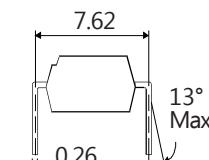
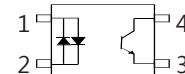
OPTION G



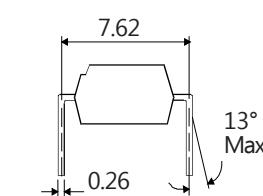
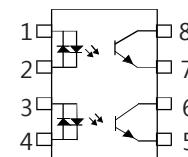
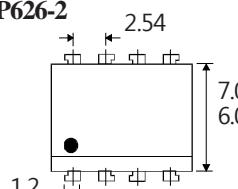
**ISP626-1X
ISP626-1**



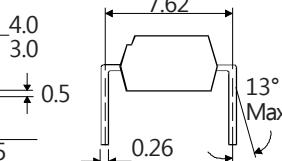
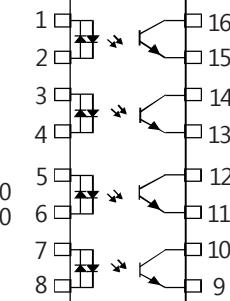
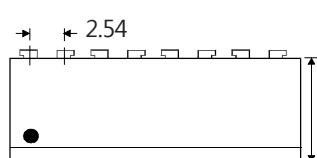
Dimensions in mm



**ISP626-2X
ISP626-2**

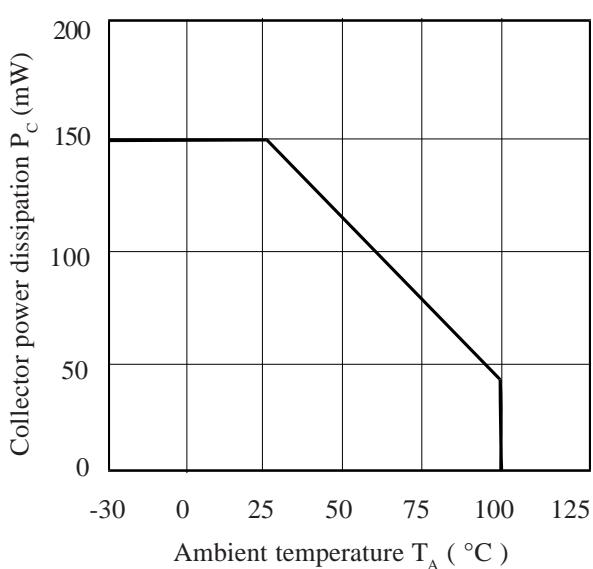


**ISP626-4X
ISP626-4**

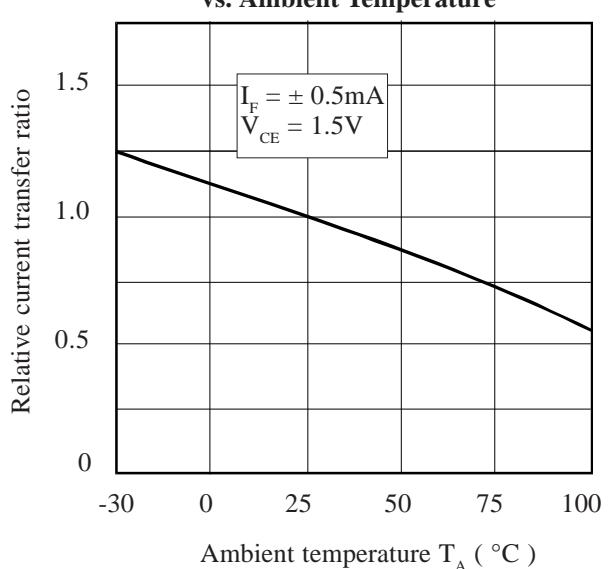


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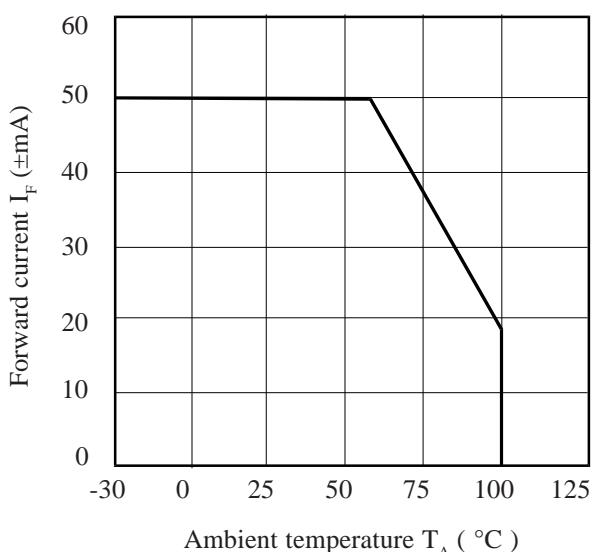
Collector Power Dissipation vs. Ambient Temperature



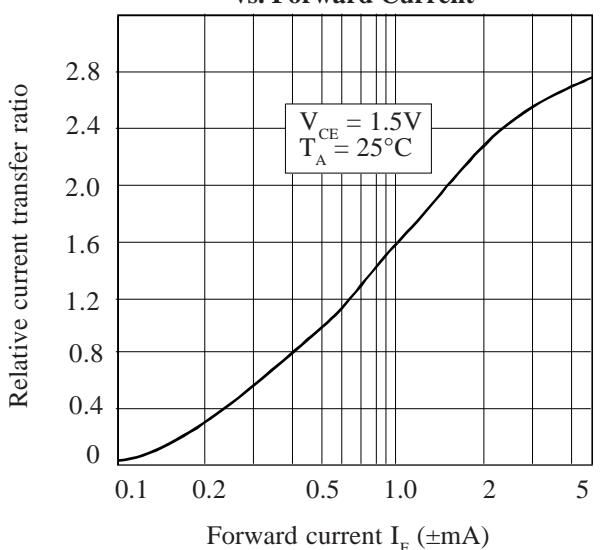
Relative Current Transfer Ratio vs. Ambient Temperature



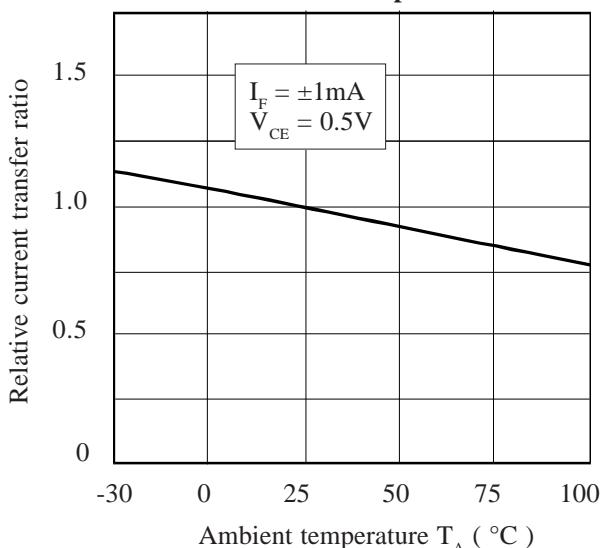
Forward Current vs. Ambient Temperature



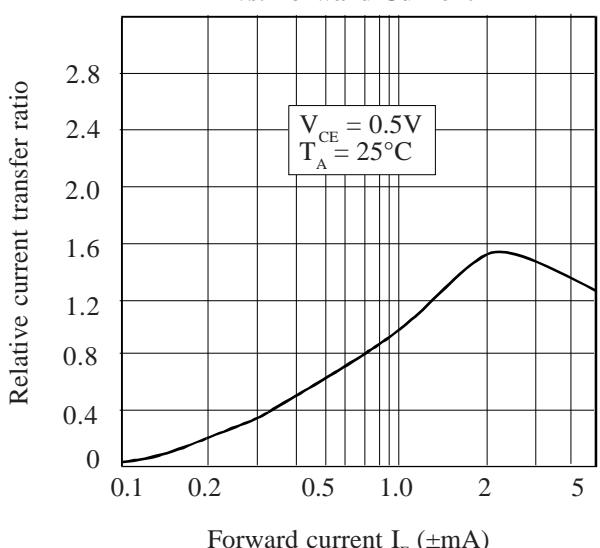
Relative Current Transfer Ratio vs. Forward Current



Relative Current Transfer Ratio vs. Ambient Temperature



Relative Current Transfer Ratio vs. Forward Current



ABSOLUTEMAXIMUMRATINGS
(25°C unless otherwise specified)

Storage Temperature	—	-55°C to +125°C
Operating Temperature	—	-30°C to +100°C
Lead Soldering Temperature (1/16 inch (1.6mm) from case for 10 secs)		260°C

INPUTDIODE

Forward Current	—	±50mA
Power Dissipation	—	70mW

OUTPUTTRANSISTOR

Collector-emitter Voltage BV _{CEO}	—	55V
Emitter-collector Voltage BV _{ECO}	—	6V
Collector Current	—	50mA
Power Dissipation	—	150mW

POWERDISSIPATION

Total Power Dissipation	—	200mW
(derate linearly 2.67mW/°C above 25°C)		

ELECTRICAL CHARACTERISTICS (T_A = 25°C Unless otherwise noted)

PARAMETER		MIN	TYP	MAX	UNITS	TEST CONDITION
Input	Forward Voltage (V _F)	1.0	1.15	1.3	V	I _F = ± 10mA
Output	Collector-emitter Breakdown (BV _{CEO}) (Note 2)	55			V	I _C = 0.5mA
	Emitter-collector Breakdown (BV _{ECO})	6			V	I _E = 100µA
	Collector-emitter Dark Current (I _{CEO})			100	nA	V _{CE} = 24V
Coupled	Current Transfer Ratio (CTR) (Note 2) Low Input CTR	100 50		1200	% %	± 1mA I _F , 0.5V V _{CE} ± 0.5mA I _F , 1.5V V _{CE}
	Collector-emitter Saturation Voltage V _{CE(SAT)}		0.2	0.4	V V	± 1mA I _F , 0.5mA I _C ± 1mA I _F , 1mA I _C
	Input to Output Isolation Voltage V _{ISO}	5300 7500			V _{RMS} V _{PK}	See note 1 See note 1
	Input-output Isolation Resistance R _{ISO}	5x10 ¹⁰			Ω	V _{IO} = 500V (note 1)
	Rise Time, tr Fall Time, tf		4 3		µs µs	V _{CE} = 2V, I _C = 2mA, R _L = 100Ω

Note 1 Measured with input leads shorted together and output leads shorted together.

Note 2 Special Selections are available on request. Please consult the factory.